

Customer Information Notification

Issue Date: 16-Oct-2014
Effective Date: 15-Nov-2014

Here's your personalized quality information concerning products Digi-Key purchased from NXP. For detailed information we invite you to view this notification online

2014100021



Management Summary

- The product data sheet version Rev. 3 (issue date 24 September 2013) is incorrect.
- Correct the product data sheet for CBT3253A.

Change Category

[] Wafer Fab process [] Assembly Process [] Product Marking			[] Design
[] Wafer Fab	[] Assembly	[X] Electrical spec./Test	[] Mechanical Specification
materials	Materials	coverage	
[] Wafer Fab location [] Assembly Location[] Test Location			[] Packing/Shipping/Labeling

Product data sheet CBT3253A update to address errata

Information Notification

Update of product data sheet CBT3253A.

- Product data sheet CBT3253A update to address errata.
- The product data sheet CBT3235A has been updated to Rev. 4 (issue date 9 October 2014), see attachment.

Following modifications / corrections are performed:

- Section 1 "General description": text changed to align with the function of the device.
- Figure 1 "Logic diagram": schematic changed.
- Table 3 "Function selection": switch description changed to align with the function of the device.
- Table 7 "Dynamic characteristics": typo corrected, the conditions for enable and disable times are swapped.

Why do we issue this Information Notification

- The product data sheet is updated, as some corrections were required.
- The update is made to ensure that the correct information is in the product data sheet.
- To notify customers that the product data sheet is updated.

Identification of Affected Products

Product identification does not change.

Impact

No impact on product performance (product data sheet error).

Data Sheet Revision

A new datasheet will be issued

Disposition of Old Products

Not applicable, no changes in the product itself, this is only a product data sheet update.

Remarks

- No process / wafer fab change.
- No assembly / final test location change.
- No design change.
- Product data sheet has been updated, see attachment.
- Updated product data sheet available on internet.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

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Position QA engineering Logic Products

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